# 74LVC169

# Presettable synchronous 4-bit up/down binary counter

Rev. 05 — 8 June 2009

**Product data sheet** 

# 1. General description

The 74LVC169 is a synchronous presettable 4-bit binary counter which features an internal look-ahead carry circuitry for cascading in high-speed counting applications. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs (pins Q0 to Q3) change simultaneously with each other when so instructed by the count-enable (pins  $\overline{\text{CEP}}$  and  $\overline{\text{CET}}$ ) inputs and internal gating. This mode of operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters. A buffered clock (pin CP) input triggers the four flip-flops on the LOW-to-HIGH transition of the clock.

The counter is fully programmable; that is, the outputs may be preset to any number between 0 and its maximum count. Presetting is synchronous with the clock and takes place regardless of the levels of the count enable inputs. A LOW level on the parallel enable (pin  $\overline{PE}$ ) input disables the counter and causes the data at the Dn input to be loaded into the counter on the next LOW-to-HIGH transition of the clock. The direction of the counting is controlled by the up/down (pin  $U/\overline{D}$ ) input. When pin  $U/\overline{D}$  is HIGH, the counter counts up, when LOW, it counts down.

The look-ahead carry circuitry is provided for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable (pins  $\overline{\text{CEP}}$  and  $\overline{\text{CET}}$ ) inputs and a terminal count (pin  $\overline{\text{TC}}$ ) output. Both count-enable (pins  $\overline{\text{CEP}}$  and  $\overline{\text{CET}}$ ) inputs must be LOW to count. Input pin  $\overline{\text{CET}}$  is fed forward to enable the terminal count (pin  $\overline{\text{TC}}$ ) output. Pin  $\overline{\text{TC}}$  thus enabled will produce a LOW-level output pulse with a duration approximately equal to a HIGH level portion of pin Q0 output. The LOW level pin  $\overline{\text{TC}}$  pulse is used to enable successive cascaded stages.

The 74LVC169 uses edge triggered J-K type flip-flops and has no constraints on changing the control of data input signals in either state of the clock. The only requirement is that the various inputs attain the desired state at least a set-up time before the next LOW-to-HIGH transition of the clock and remain valid for the recommended hold time thereafter.

The parallel load operation takes precedence over the other operations, as indicated in the mode select table. When pin  $\overline{PE}$  is LOW, the data on the input pins D0 to D3 enters the flip-flops on the next LOW-to-HIGH transition of the clock.



#### Presettable synchronous 4-bit up/down binary counter

In order for counting to occur, both pins  $\overline{\text{CEP}}$  and  $\overline{\text{CET}}$  must be LOW and pin  $\overline{\text{PE}}$  must be HIGH. The pin U/ $\overline{\text{D}}$  input determines the direction of the counting. The terminal count output pin  $\overline{\text{TC}}$  output is normally HIGH and goes LOW, provided that pin  $\overline{\text{CET}}$  is LOW, when a counter reaches 15 in the count up mode. The pin  $\overline{\text{TC}}$  output state is not a function of the count-enable parallel (pin  $\overline{\text{CEP}}$ ) input level. Since pin  $\overline{\text{TC}}$  signal is derived by decoding the flip-flop states, there exists the possibility of decoding spikes on pin  $\overline{\text{TC}}$ . For this reason the use of pin  $\overline{\text{TC}}$  as a clock signal is not recommended; see the following logic equations:

```
count enable = \overline{CEP} \bullet \overline{CET} \bullet \overline{PE}

count up: TC = Q3 \bullet Q2 \bullet Q1 \bullet Q0 \bullet CET \bullet U/\overline{D}

count down: TC = \overline{Q3} \bullet \overline{Q2} \bullet \overline{Q1} \bullet \overline{Q0} \bullet CET \bullet \overline{U}/D
```

#### 2. Features

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Up/down counting
- Two count enable inputs for n-bit cascading
- Built-in look-ahead carry capability
- Presettable for programmable operation
- Complies with JEDEC standard JESD8-B / JESD36
- ESD protection:
  - ◆ HBM JESD22-A114D exceeds 2000 V
  - CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C.

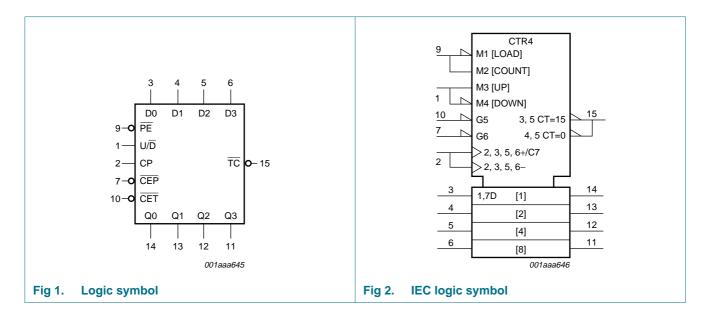
# 3. Ordering information

Table 1. Ordering information

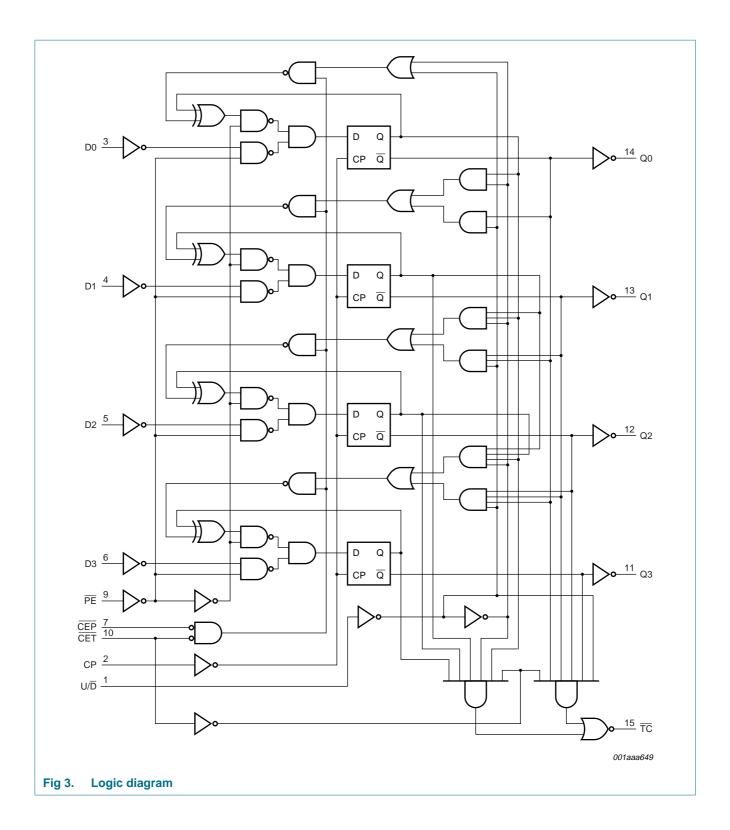
Type number	Temperature range	Package		
		Name	Description	Version
74LVC169D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74LVC169DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74LVC169PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74LVC169BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5\times3.5\times0.85$ mm	SOT763-1

# Presettable synchronous 4-bit up/down binary counter

# 4. Functional diagram



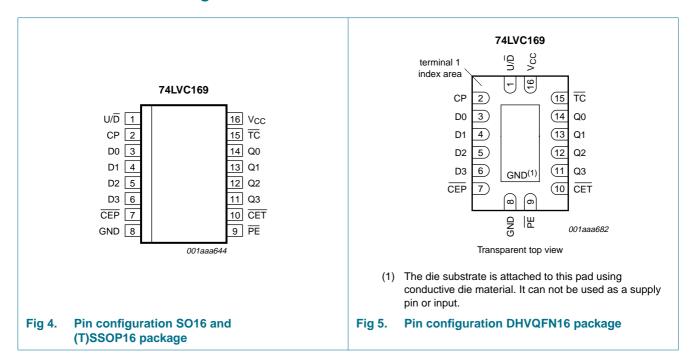
# Presettable synchronous 4-bit up/down binary counter



### Presettable synchronous 4-bit up/down binary counter

# 5. Pinning information

### 5.1 Pinning



# 5.2 Pin description

Table 2. Pin description

	шооот.рот.	
Symbol	Pin	Description
$U/\overline{D}$	1	up/down control input
CP	2	clock input (LOW-to-HIGH, edge-triggered)
D0 to D3	3, 4, 5, 6	data input
CEP	7	count enable input (active LOW)
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input (active LOW)
Q0 to Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output (active LOW)
$V_{CC}$	16	supply voltage

### Presettable synchronous 4-bit up/down binary counter

# 6. Functional description

Table 3. Function table [1]

Operating modes	Input		Output	Output				
	СР	U/D	CEP	CET	PE	Dn	Qn	TC
Parallel load (Dn to Qn)	$\uparrow$	Χ	Χ	Χ	I	I	L	*
	$\uparrow$	Χ	Χ	Χ	I	h	Н	*
Count up (increment)	<b>↑</b>	h	I	I	h	Χ	count up	*
Count down (decrement)	<b>↑</b>	I	I	I	h	Χ	count down	*
Hold (do nothing)	<b>↑</b>	Χ	h	Χ	h	Χ	qn	*
	$\uparrow$	Χ	Χ	Χ	h	Χ	qn	Н

#### [1] H = HIGH voltage level steady state

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level steady state

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

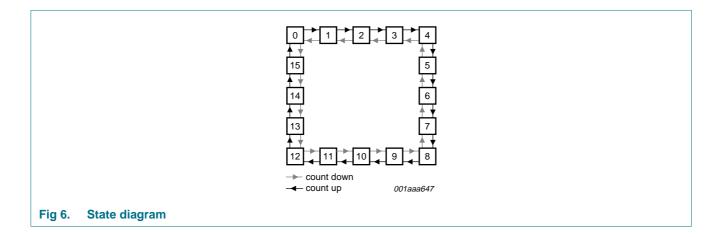
qn = Lower case letters indicate state of referenced output prior to the LOW-to-HIGH clock transition

X = don't care

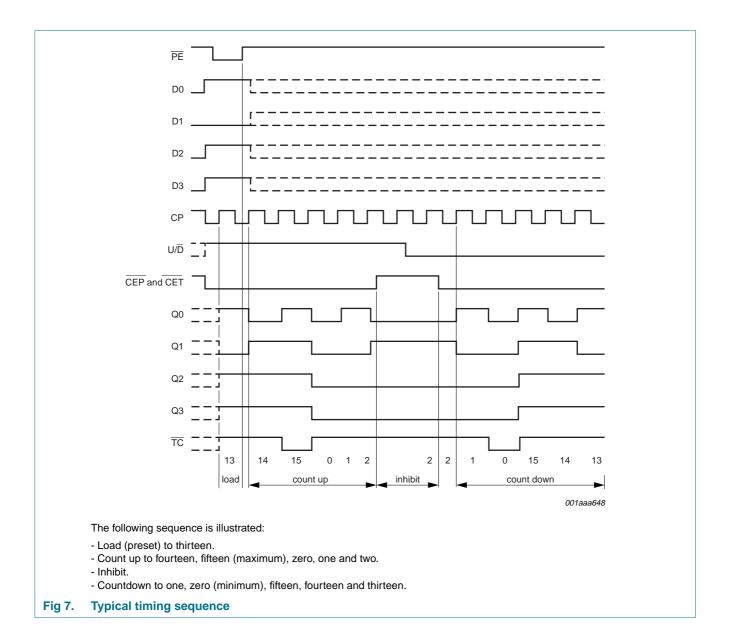
↑ = LOW-to-HIGH clock transition

\* = The  $\overline{TC}$  is LOW when  $\overline{CET}$  is LOW and the counter is at terminal count

Terminal count up is (HHHH) and terminal count down is (LLLL)



# Presettable synchronous 4-bit up/down binary counter



### Presettable synchronous 4-bit up/down binary counter

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
$I_{IK}$	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		[ <u>1</u> ] -0.5	+5.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
$V_{O}$	output voltage		[ <u>1</u> ] -0.5	$V_{CC} + 0.5$	V
I <sub>O</sub>	output current		-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	<u>[2]</u> _	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage for maximum speed performance		2.7	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
$V_{I}$	input voltage		0	-	5.5	V
Vo	output voltage		0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V <sub>CC</sub> = 1.2 V to 2.7 V	0	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO16 packages: above 70 °C, P<sub>tot</sub> derates linearly with 8 mW/K.

For (T)SSOP16 packages: above 60 °C, P<sub>tot</sub> derates linearly with 5.5 mW/K.

For DHVQFN16 packages: above 60 °C, P<sub>tot</sub> derates linearly with 4.5 mW/K.

# Presettable synchronous 4-bit up/down binary counter

# 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.2 V	$V_{CC}$	-	-	$V_{CC}$	-	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	GND	-	GND	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
$V_{OH}$	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
output voltage	$I_{O} = -100 \ \mu A; \ V_{CC} = 2.7 \ V \ to \ 3.6 \ V$	V <sub>CC</sub> - 0.2	$V_{CC}$	-	$V_{CC}-0.3$	-	V	
	voltage	$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
$V_{OL}$	V <sub>OL</sub> LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output	$I_O$ = 100 $\mu$ A; $V_{CC}$ = 2.7 V to 3.6 V	-	GND	0.2	-	0.3	V
	voltage	$I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I <sub>I</sub>	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC}$ = 1.65 V to 3.6 V; $V_I = V_{CC} - 0.6$ V; $I_O$ = 0 A	-	5	500	-	5000	μΑ
C <sub>I</sub>	input capacitance	$V_{CC}$ = 0 V to 3.6 V; $V_{I}$ = GND to $V_{CC}$	-	5.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

# Presettable synchronous 4-bit up/down binary counter

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	CP to Qn; see Figure 8	[2]		•				
		V <sub>CC</sub> = 1.2 V		-	17	-	-	-	ns
		V <sub>CC</sub> = 2.7 V		1.5	-	7.2	1.5	9.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.5	4.0	6.6	1.5	8.5	ns
		CP to TC; see Figure 8	[2]						
		V <sub>CC</sub> = 1.2 V		-	21	-	-	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	-	8.8	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	4.8	7.5	1.5	9.5	ns
		CET to TC; see Figure 9	[2]						
		V <sub>CC</sub> = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	-	7.2	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	4.1	6.2	1.5	8.0	ns
		U/D to TC; see Figure 10	[2]						
		V <sub>CC</sub> = 1.2 V		-	21	-	-	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	-	8.2	1.5	10.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.7	6.9	1.5	9.0	ns
$t_W$	pulse width	CP HIGH or LOW; see Figure 8							
		$V_{CC} = 2.7 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.0	1.2	-	4.0	-	ns
$t_{su}$	set-up time	Dn to CP; see Figure 11							
		$V_{CC} = 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.5	1.0	-	2.5	-	ns
		PE to CP; see Figure 11							
		$V_{CC} = 2.7 \text{ V}$		3.5	-	-	3.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	1.2	-	3.0	-	ns
		U/D to CP; see Figure 12							
		$V_{CC} = 2.7 \text{ V}$		6.5	-	-	6.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		5.5	2.8	-	5.5	-	ns
		CEP, CET to CP; see Figure 12							
		$V_{CC} = 2.7 \text{ V}$		5.5	-	-	5.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.5	2.1	-	4.5	-	ns
t <sub>h</sub>	hold time	Dn, $\overline{PE}$ , $\overline{CEP}$ , $\overline{CET}$ , U/ $\overline{D}$ to CP; see Figure 11 and 12							
		$V_{CC} = 2.7 \text{ V}$		0.0	-	-	0.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	0.0	-	0.5	-	ns

### Presettable synchronous 4-bit up/down binary counter

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
f <sub>max</sub> maximum		see Figure 8							
frequency	$V_{CC} = 2.7 \text{ V}$		150	-	-	150	-	MHz	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		150	200	-	150	-	MHz
t <sub>sk(0)</sub>	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per input pin; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	capacitance	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	20	-	-	-	pF

- [1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.2$  V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

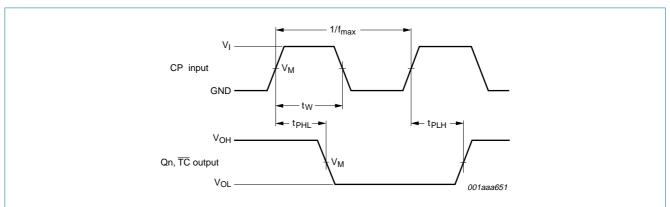
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs

# 11. Waveforms

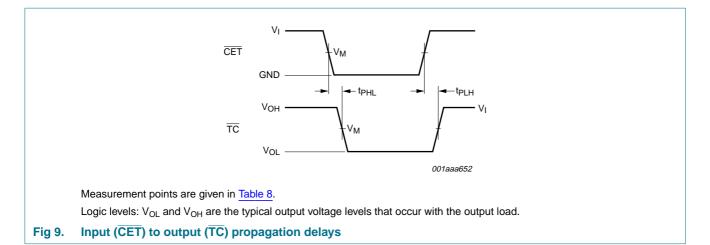


Measurement points are given in Table 8.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

Fig 8. Clock (CP) to outputs (Qn, TC) propagation delays, the clock pulse width, and the maximum frequency

### Presettable synchronous 4-bit up/down binary counter



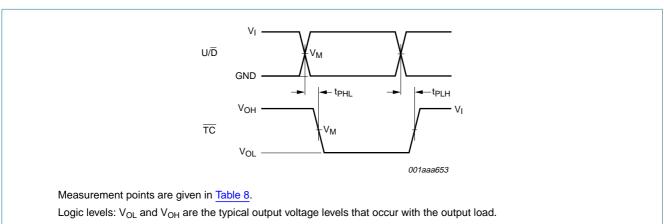
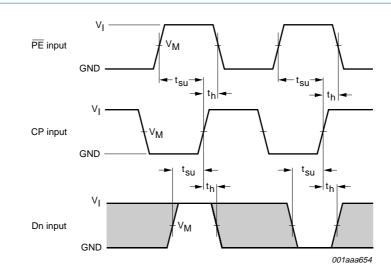


Fig 10. The up/down control input  $(U/\overline{D})$  to output  $(\overline{TC})$  propagation delays

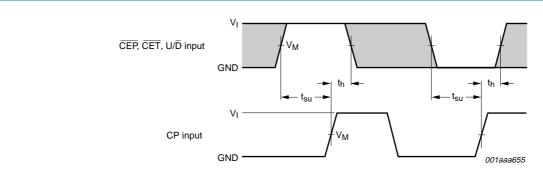
### Presettable synchronous 4-bit up/down binary counter



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

Fig 11. Set-up and hold times for the input (Dn) and parallel enable input (PE)



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

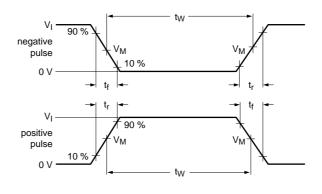
Logic levels:  $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

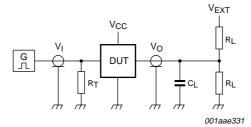
Fig 12. Set-up and hold times for count enable inputs ( $\overline{\text{CEP}}$  and  $\overline{\text{CET}}$ ) and control input ( $U/\overline{D}$ )

Table 8. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>
1.2 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V

# Presettable synchronous 4-bit up/down binary counter





Test data is given in Table 9.

Definitions for test circuit:

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

Fig 13. Test circuit for measuring switching times

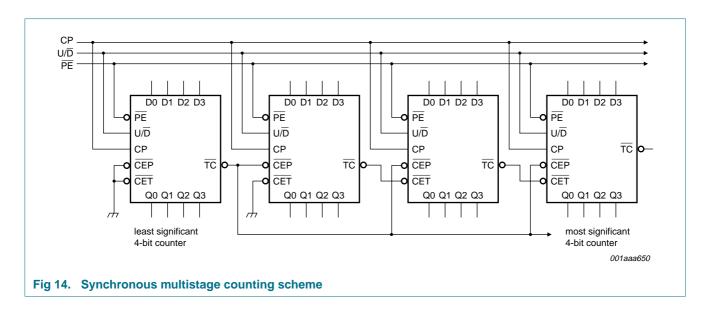
Table 9. Test data

Supply voltage	Input		Load	S1 position	
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> : t <sub>PHL</sub>
1.2 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω[1]	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open

[1] The circuit preforms better when  $R_L$  = 1000  $k\Omega$ .

### Presettable synchronous 4-bit up/down binary counter

# 12. Application information

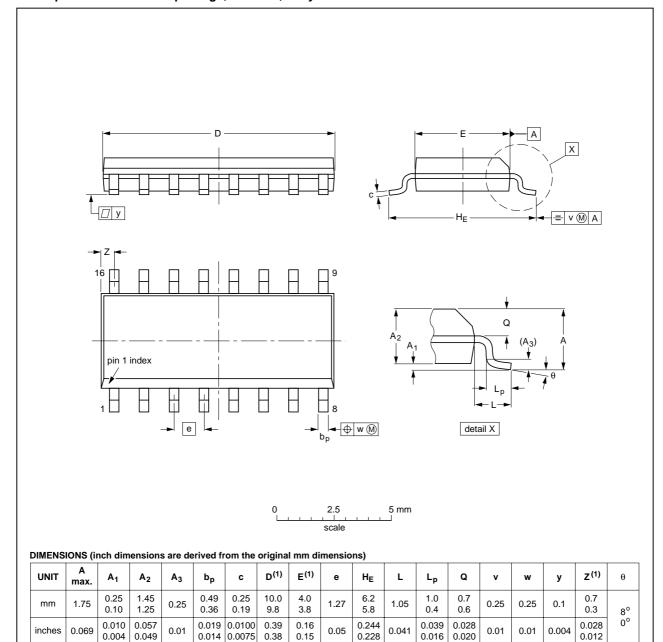


### Presettable synchronous 4-bit up/down binary counter

# 13. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

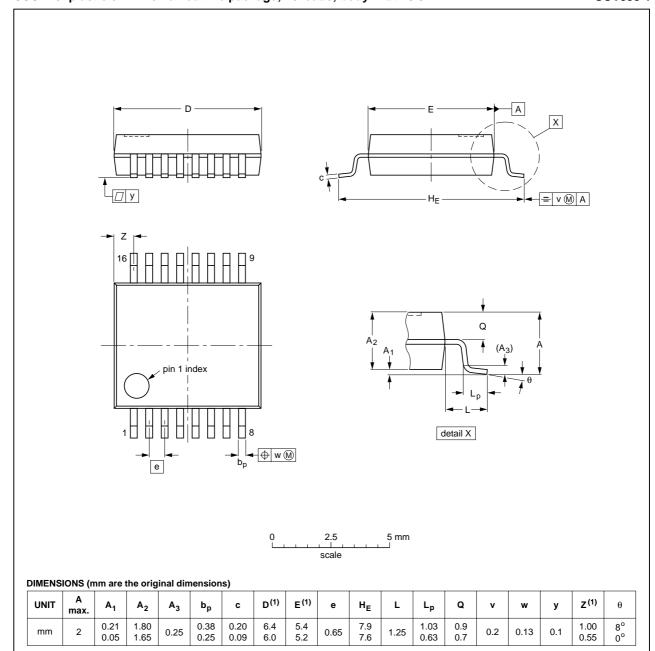
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19	

Fig 15. Package outline SOT109-1 (SO16)

### Presettable synchronous 4-bit up/down binary counter

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ICCUIE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT338-1		MO-150				<del>99-12-27</del> 03-02-19	

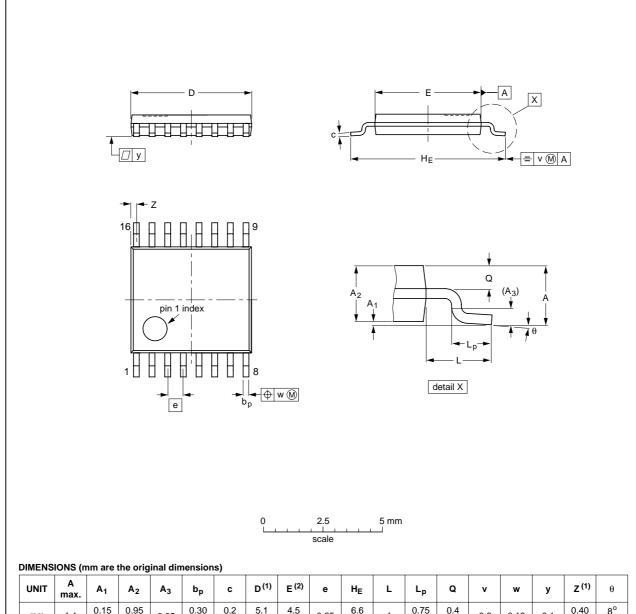
Fig 16. Package outline SOT338-1 (SSOP16)

74LVC169 **NXP Semiconductors** 

# Presettable synchronous 4-bit up/down binary counter

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



ι	JNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

JEDEC	JEITA		PROJECTION	ISSUE DATE
/IO-153				<del>-99-12-27</del> 03-02-18
/	IO-153	IO-153	IO-153	10-153

Fig 17. Package outline SOT403-1 (TSSOP16)

### Presettable synchronous 4-bit up/down binary counter

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

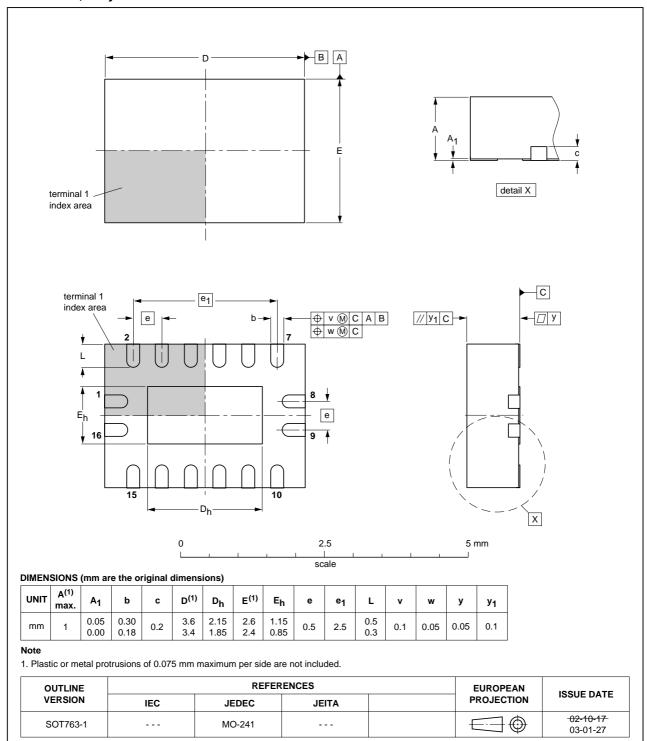


Fig 18. Package outline SOT763-1 (DHVQFN16)

# Presettable synchronous 4-bit up/down binary counter

# 14. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

# 15. Revision history

#### Table 11. Revision history

	•								
Document ID	Release date	Data sheet status	Change notice	Supersedes					
74LVC169_5	20090608	Product data sheet	-	74LVC169_4					
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>								
	<ul> <li>Legal texts have been updated and adapted to the new company name where appropriate.</li> </ul>								
	<ul> <li><u>Table 7 "Dynamic characteristics"</u> 3.0 V to 3.6 V max t<sub>PLH</sub> and t<sub>PHL</sub> values changed due to ECN06_058.</li> </ul>								
74LVC169_4	20041014	Product specification	-	74LVC169_3					
74LVC169_3	20040512	Product specification	-	74LVC169_2					
74LVC169_2	19980520	Product specification	-	74LVC169_1					
74LVC169_1	19960823	Product specification	-	-					

#### Presettable synchronous 4-bit up/down binary counter

# 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 16.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

### 16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

#### 17. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

% NXP B.V. 2009. All rights reserved.

### Presettable synchronous 4-bit up/down binary counter

# 18. Contents

1	General description	ı
2	Features 2	2
3	Ordering information	<u>)</u>
4	Functional diagram 3	3
5	Pinning information 5	5
5.1	Pinning	5
5.2	Pin description	
6	Functional description 6	j
7	Limiting values 8	3
8	Recommended operating conditions 8	3
9	Static characteristics	)
10	Dynamic characteristics	)
11	Waveforms	l
12	Application information	5
13	Package outline	j
14	Abbreviations	)
15	Revision history	)
16	Legal information	
16.1	Data sheet status 21	
16.2	Definitions	
16.3	Disclaimers	
16.4	Trademarks21	
17	Contact information 21	
18	Contents	<u> </u>

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



© NXP B.V. 2009.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 8 June 2009

Document identifier: 74LVC169\_5